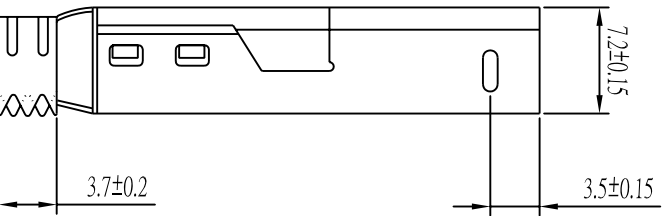
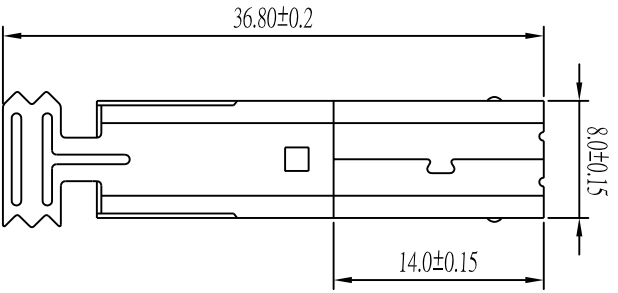
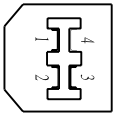
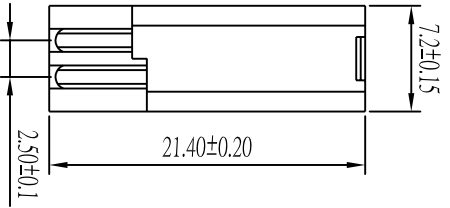
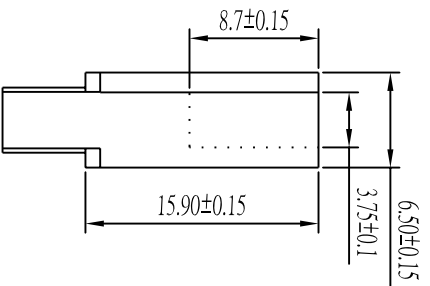


REV.	ECN NO.	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD



- Note:
1. Material:
 1.1 Insulator: High temperature thermoplastic with g.f.U194V-0
 1.2 Contact: Copper alloy,t=0.20mm
 1.3 Shell: Spcc,t=0.30mm
2. Specification:
 2.1 Current rating: 1 A Max.
 2.2 Dielectric withstanding voltage: 750 V(ac) for 1 min.
 2.3 Contact resistance: 30 mΩ Max.
 2.4 Insulation resistance: 1000 MΩ Min.
 2.5 Total mating force: 4.0 Kgf Max.
 2.6 Total unmating force: 1.0 Kgf Min.
 2.7 Temperature range: -55°C~85°C

No.	Name	Qty	Part No.	Finish
8	Back-shell			
7	Front-shell			
6	Clip			No finish
5	Contact			
4	Contact			
3	Contact			Selective Au plated on mating area
2	Contact			
1	Housing			Black

PART NO:		MATERIAL:	
MODEL NO:		FINISH:	
UNIT: mm	SIZE:	COLOR:	
TOLERANCE UNSPECIFIED			
x	±0.3	DR:	
.xx	±0.20	CHK:	
.xxx	±0.100	APP: 1	
ANG.	±1°	SCALE: 2:1	
PART NAME: USB-B TYPE SOLDER(A)		SHEET: 1 of 1	
HC-003		REV: A0	